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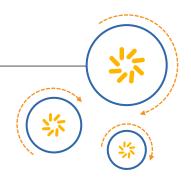






## RF360 Europe GmbH

## A Qualcomm - TDK Joint Venture



## **SAW Components**

### SAW RF low loss filter

Satellite CSS

Series/type: B1650

Ordering code: B39202B1650B510

Date: December 10, 2012

Version: 2.0

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SAW	Components		B1650			
SAW F	RF low loss filter		2040.0 MHz			
Data sheet						
Revision History: Changes compared to previous iteration issue						
ISSUE	ORIGINATOR	DETAIL SPEC CHANGES	DATE			
DGLW72S01						
0.1	HuA	Initial release	12.03.2010			
LW72A						
1.0	HuA	First sample run release	12.05.2010			
LW72B						
1.0	QuekJ	Improvement of CMDR and stop band attenuation	14.01.2011			
LW72C						
1.0	QuekJ	Improvement of insertion attenuation	27.06.2011			
1.1	HuA	Revision history page included	17.10.2011			
2.0	HuA	Mass Production release	10.12.2012			



SAW Components B1650

#### SAW RF low loss filter 2040.0 MHz

**Data sheet** 



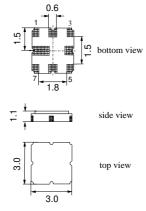
#### **Application**

- Low loss RF filter for satellite CSS
- Usable passband 60.0 MHz
- Balanced to balanced operation



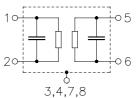
#### **Features**

- Package size 3.0 x 3.0 x 1.1 mm<sup>3</sup>
- Maximum height of 1.225 mm
- Package code QCC8F
- RoHS compatible
- Approximate weight 0.037 g
- Package for Surface Mount Technology (SMT)
- Ni, gold-plated terminals
- Electrostatic Sensitive Device (ESD)



#### Pin configuration

- 1 Input
- 2 Input
- 5 Output
- 6 Output
- 3,7 To be grounded
- 4,8 Case ground, to be grounded





SAW Components B1650

**SAW RF low loss filter** 2040.0 MHz

**Data sheet** 

#### **Characteristics**

Temperature range for specification: -40 °C to +85 °C

Terminating source impedance: Z<sub>S</sub> = 150  $\Omega$  (balanced) and matching network Terminating load impedance: 150  $\Omega$  (balanced) and matching network

		min.	typ. @ 25 °C	max.	
Nominal frequency	f <sub>N</sub>	_	2040.0	<del>_</del>	MHz
Maximum insertion attenuation 2010.0 2070.0 MH	$lpha_{\sf max}$ z	_	4.1	5.0	dB
Pass bandwidth $\alpha_{\text{rel}} \leq 1.5 \text{ dB}$	B <sub>1.5 dB</sub>	_	79.0	_	MHz
Amplitude ripple (p-p) 2010.0 2070.0 MH	$\Delta lpha$ z	_	1.2	2.0	dB
Input return loss		7.4	9.5	_	dB
Output return loss		7.4	9.5	_	dB
<b>Group delay ripple (p-p)</b> 2010.0 2070.0 MH	$\Delta au$ z	_	20.0	40.0	ns
<b>CMDR</b> 2010.0 2070.0 MH	Z	20.0	27.0	_	dB
<b>Deviation from linear phase (rms)</b> in any 30 MHz band					
2010.0 2070.0 MH	Z	_	4.0	6.0	o
Attenuation 50.0 1950.0 MH 2130.0 3000.0 MH 3000.0 6000.0 MH	Z	40 40 35	48 43 46	_ _ _	dB dB dB



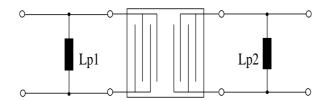
SAW Components B1650

#### SAW RF low loss filter 2040.0 MHz

**Data sheet** 



Matching network (element values depend on PCB layout)



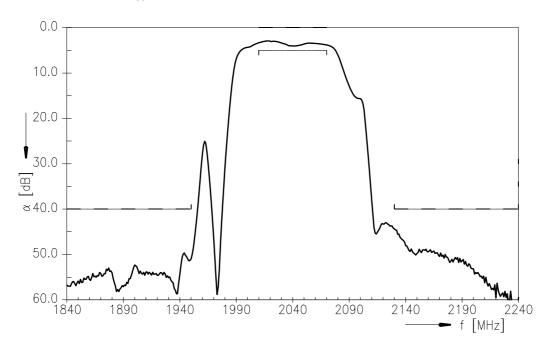
$$L_{p1} = 12 \text{ nH}$$
  
 $L_{p2} = 12 \text{ nH}$ 

#### **Maximum ratings**

Operable temperature range T		-40/+85	°C	
Storage temperature range	$T_{stg}$	-40/+85	°C	
DC voltage	$V_{DC}$	0	V	
ESD voltage	$V_{ESD}$	50 <sup>1)</sup>	V	machine model, 1 pulse
Input power at				
1390.0 1450.0 MHz	$P_{IN}$	0	dBm	source impedance 150 $\Omega$

<sup>1)</sup> acc. to JESD22-A115A (machine model), 1 negative & 1 positive pulse.

#### Transfer function S<sub>dd21</sub>



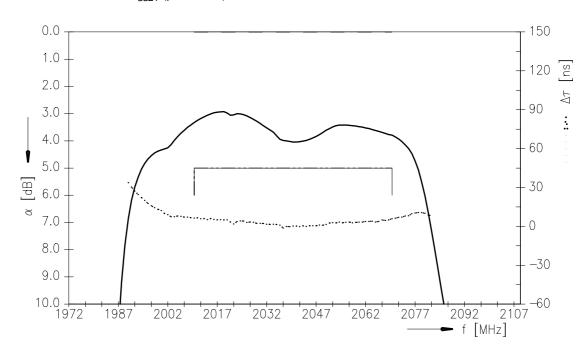




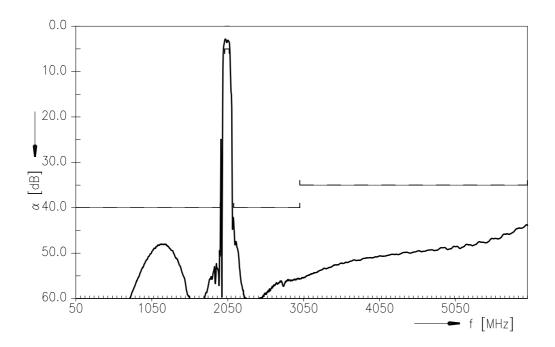
**Data sheet** 



#### **Transfer function** S<sub>dd21</sub> (passband)



#### Transfer function $S_{dd21}$ (wideband)





SAW Components	B1650
SAW RF low loss filter	2040.0 MHz

**Data sheet** 



#### References

Туре	B1650
Ordering code	B39202B1650B510
Marking and package	C61157-A7-A72
Packaging	F61074-V8168-Z000
Date codes	L_1126
S-parameters	B1650_NB.s4p; B1650_WB.s4p
Soldering profile	S_6001
RoHS compatible	defined as compatible with the following documents: "DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment. 2005/618/EC from April 18th, 2005, amending Directive 2002/95/EC of the European Parliament and of the Council for the purposes of establishing the maximum concentration values for certain hazardous substances in electrical and electronic equipment."
Moldability	Before using in overmolding environment, please contact your EPCOS sales office.
Matching coils	See Inductor pdf-catalog <a href="http://www.tdk.co.jp/tefe02/coil.htm#aname1">http://www.tdk.co.jp/tefe02/coil.htm#aname1</a> and Data Library for circuit simulation <a href="http://www.tdk.co.jp/etvcl/index.htm">http://www.tdk.co.jp/etvcl/index.htm</a>

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